

SEA & LAND ELECTRONIC CORP.

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ALPHA-TOP TECHNOLOGY CORP.

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APPROVAL SHEET

MODEL NO.:	SMD1210-020-60V		
CUSTOMER:			
CUSTOMER'S APF	PROVAL:		
AUTHORIZED SIGI	NATURE/STAMP:		
DATE			

MANUFACTURER:

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Submitted by: Chung Cheng Approved by: YC Lin DATE: 2-Mar-22

SEA & LAND ELECTRONIC CORP.



Features

■ Surface Mount Devices

■ Lead free device

■ Size 3.2*2.5mm/0.12*0.10 i

■ Surface Mount packaging for automated assembly

Applications

Almost anywhere there is a low voltage power supply, up to 30V and a load to be

protected, including:

Computer mother board, Modem.

■ Telecommunication equipments.

SMD1210-020-60V

Alpha-Top (Sea&Land Alliance)

Performance Specification

						Maximum Resistance			tanco			
Model	Maukina	V_{max}	I _{max}	I _{hold}	I _{trip}	P_d	Time 1	Го Trip	Resis	starice	Agency	Approval
Model	Marking			@25°C	@25°C	Max.	Current	Time	Ri_{min}	R1max	UL	TUV
		(Vdc)	(A)	(A)	(A)	(W)	(A)	(Sec)	(Ω)	(Ω)	UL	100
SMD1210-020-60V	α C	60	100	0.20	0.40	0.6	8.0	0.02	0.400	5.000		

Ihold = Hold Current. Maximum current device will not trip in 25°C still air.

Itrip = Trip Current. Minimum current at which the device will always trip in 25°C still air.

Vmax = Maximum operating voltage device can withstand without damage at rated current (Imax).

Imax = Maximum fault current device can withstand without damage at rated voltage (Vmax).

Pd = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.

R1_{max} = Maximum device resistance is measured one hour post reflow.

CAUTION: Operation beyond the specified ratings may result in damage and possible arcing and flame.

Environmental Specifications

Test	Conditions	Resistance change					
Passive aging	+85°C, 1000 hrs.	±5% typical					
Humidity aging	+85°C, 85% R.H., 168 hours	±5% typical					
Thermal shock	+85°C to -40°C, 20 times	±33% typical					
Resistance to solvent	MIL-STD-202,Method 215	No change					
Vibration	MIL-STD-202,Method 201	No change					
Ambient operating conditions : - 40 °C to +85 °C							
Maximum surface temperature of the device in the tripped state is 125 °C							

AGENCY APPROVALS:

Regulation/Standard:



2015/863/EU

HF

EN14582

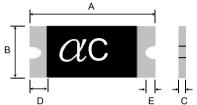
I_{hold} Versus Temperature

noid torous romporate											
Model		Maximum ambient operating temperature (T _{mao}) vs. hold current (I _{hold})									
Model	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C		
SMD1210-020-60V	0.29	0.26	0.22	0.20	0.16	0 14	0.13	0.11	0.08		

Construction And Dimension (Unit:mm)

		,						
Model		Α		В		С		E
Model	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.
SMD1210-020-60V	3.00	3.43	2.35	2.80	0.40	0.90	0.30	0.10

Dimensions & Marking



α = TrademarkC = Part identification

Recommended Pad Layout (mm) 1.0±0.1 1.0±0.1 1.0±0.1 1.0±0.1 1.0±0.1

2.0±0.1

Termination Pad Characteristics

Terminal pad materials :

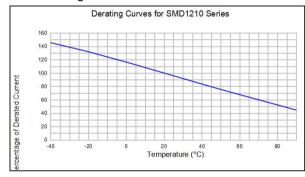
Tin-plated Nickel-Copper

Terminal pad solderability: Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

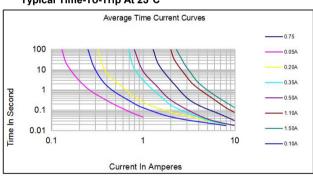
Rework

Use standard industry practices, the removal device must be replaced with a fresh one.

Thermal Derating Curve

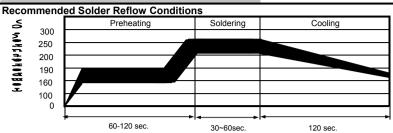


Typical Time-To-Trip At 25°C



NARNING:

- · Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
- PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- · Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
 · Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.
- Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.
- · Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.
- · Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profile could negatively impact solderability performance of our devices.



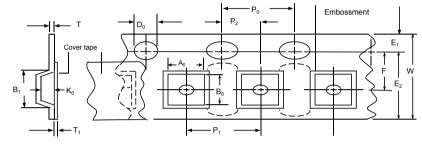
- Recommended reflow methods : IR, vapor phase oven, hot air oven.
- Devices are not designed to be wave soldered to the bottom side of the board.
- Recommended maximum paste thickness is 0.25 mm (0.010 inch).
- Devices can be cleaned using standard method and solvents.

Note: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

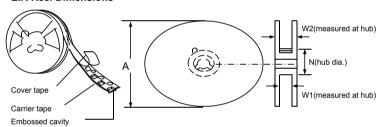
Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-2
W	8.0 ± 0.20
P0	4.0 ± 0.10
P1	4.0 ± 0.10
P2	2.0 ± 0.10
A0	2.90± 0.20
B0	3.65± 0.20
B1max.	4.35
D0	1.5± 0.10
F	3.5 ± 0.10
E1	1.75 ± 0.10
E2min.	6
Tmax.	0.3
T1max.	0.06
К0	1.00 ± 0.1
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	180
N min.	50
W1	9.00 ±2.00
W2max.	15
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EIA Tape Component Dimensions



EIA Reel Dimensions



Storage And Handling

- Storage conditions : 40°C max, 70% R.H.
- Devices may not meet specified performance if storage conditions are exceeded.

Order Information Packaging

SMD1210	020-60V	Tape & Reel Quantity
Product name	Hold	
Size 3225 mm / 1210 inch	Current	4,500 pcs/reel
SMD: surface mount device	0.20A	

Tape & reel packaging per EIA481-1

Labeling Information

